PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DAH-BIN KAO	11/25/2009

RECEIVING PARTY DATA

Name:	Semiconductor Manufacturing International (Shanghai) Corporation
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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	11387248	

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NAME OF SUBMITTER: Dah-Bin Kao

Total Attachments: 5

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501026087 REEL: 023577 FRAME: 0582

PATENT

10.00 1138724

Docket No.: 021653-005010US

Client Ref. No.: 2003-00178-SH-US-DA1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Confirmation No.: 6064

Art Unit: 2891

Examiner: Sarkar, Asok K

COMMUNICATION REGARDING

BY A NON-SIGNING INVENTOR

ASSIGNMENT OF PATENT APPLICATION

In re application of:

CHRIS C. YU et al.

Application No.: 11/387,248

Filed: March 22, 2006

For: A METHOD AND STRUCTURE

FOR ALUMINUM CHEMICAL MECHANICAL POLISHING

Customer No.: 20350

Commissioner for Patents
Patent Assignment
P.O. Box 1450
Alexandric VA 22213 1456

Alexandria, VA 22313-1450

Commissioner:

Submitted herewith is a copy of Patent Assignment Abstract of Title of the above-referenced patent application including assignment by three co-inventors: Chris C. Yu, Chunxiao Yang, and Herb Huang, which has been recorded in Reel/Frame No. 023428/0654. A petition under 37 C.F.R. §147(a) was filed on behalf of a fourth co-inventor, Mr. Ziru Ren, who could not be located for signature. The petition was granted on March 1, 2007.

Additionally, Mr. Ziru Ren has conveyed the right of all his company-related inventions to Semiconductor Manufacturing Int'l (Shanghai) Corporation (SMIC) in an EMPLOYEE INTELLECTUAL PROPERTY RIGHT AGREEMENT. A Chinese version of the agreement signed by Mr. Ziru Ren is hereby submitted for recordation. Also submitted is an English version of the agreement provided by SMIC.

Respectfully submitted,

/Dah-Bin Kao/

Dah-Bin Kao Reg. No. 53,092

> PATENT REEL: 023577 FRAME: 0583

CHRIS C. YU et al. PATENT

Application No.: 11/387,248

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PATENT REEL: 023577 FRAME: 0584



United States Patent and Trademark Office





Assignments on the Web > Patent Query

Patent Assignment Abstract of Title

NOTE:Results display only for issued patents and published applications. For pending or abandoned applications please consult USPTO staff.

Total Assignments: 1

Patent #: NONE Issue Dt: Application #: 11387248 Filing Dt: 03/22/2006

Publication #: 20070026557 Pub Dt: 02/01/2007
Inventors: Chris C. Yu, Chunxiao Yang, Ziru Ren, Herb Huang

Title: METHOD AND STRUCTURE FOR ALUMINUM CHEMICAL MECHANICAL POLISHING

Assignment: 1

Conveyance: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

Assignors: YU, CHRIS.C. Exec Dt: 09/01/2006

 YANG, CHUNXIAO
 Exec Dt: 08/28/2006

 HUANG, HERB
 Exec Dt: 07/17/2006

Assignee: SEMICONDUCTOR MANUFACTURING INTERNATIONAL (SHANGHAI) CORPORATION

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Search Results as of: 11/23/2009 04:14 PM

If you have any comments or questions concerning the data displayed, contact PRD / Assignments at 571-272-3350.

Web interface last modified: October 18, 2008 v.2.0.2

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Semiconductor Manufacturing International Corporation 中芯国际集成电路制造(上海)有限公司

智能财产所属权同意书

我 <u>化</u> <u>有</u> <u>你</u> 作为中心国际集成电路制造(上海)有限公司(SMIC)的一名工作人员,我所有之一切和公司业务有关的发明创造都属于公司所有,我自己完全没有所属权。发明创造方面包括:

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签名: <u>任自如</u> 日期: 17/7、260]

PATENT REEL: 023577 FRAME: 0586

^{**}本同意书项于奇回聘书日、报到日、试用期满日各签认一次。

Semiconductor Manufacturing Int'l (Shanghai) Corporation

INTELLECTURAL PROPERTY RIGHT AGREEMENT

I, _____, as an employee of Semiconductor Manufacturing Int'l (Shanghai)

Corporation (SMIC), agree that: any invention-creation which is made by me and is related to business of the company belongs to the company. I have no right in said

invention-creation at all. Said invention-creation includes:

① design or improvement on semiconductor device, equipment, element, or method;

2 design or improvement on manufacture procedure or equipment;

③ improvement on manufacture method;

④ any form of intellectual or practical invention-creation in the semiconductor industry or

scientific field development.

I agree that SMIC has complete right in said invention-creation, and SMIC can use and

dispose it. Even any related invention-creation as described above that is made within two

(at least two years) years since the termination of my employment from SMIC still belongs

to SMIC. (SMIC will reward the inventor according to the contribution of the invention

achievement.)

SMIC requires that an employee should not infringe other company's intellectual property,

or illegally use other's intellectual property (including information, document, or any

intellectual achievement related to IP) without authorization.

I agree that I'll not infringe other's intellectual property, or illegally use other's intellectual

property (including information, document, or any intellectual achievement related to IP)

without authorization. I'll not plagiarism, imitate, infringe, copy a third party's patent right,

exclusive right of trademark, or copy right, or carry out any actions against law.

Signature_____ Date ____

PATENT REEL: 023577 FRAME: 0587

RECORDED: 11/25/2009